


COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below under my name. I believe I am the sole (if only one name appears below), or a joint (if more than one name appears), original and first inventor of the subject matter which is claimed and for which a patent is sought on the invention **entitled: METHOD FOR REMOVAL OF HEMISPHERICAL GRAINED SILICON IN A DEEP TRENCH**

X The specification for the above entitled invention is filed herewith.  
\_\_\_\_\_ The specification for the above entitled invention was filed previously with application serial number \_\_\_\_\_, filed on \_\_\_\_\_

 I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to the person to be material to patentability of this application as defined in 37, C.F.R. Section 1.56(a).

PRIORITY CLAIM

\_\_\_\_\_ There is no claim of priority.  
X Claim of priority is based on the following:  
country: TAIWAN, R.O.C.; Application number: 92131135 ;the filing date: November 6, 2003

POWER OF ATTORNEY

As a named inventor, I hereby appoint the following attorney to prosecute this application and to transact all related business in the Patent and Trademark Office:

*Keith Kline, Registration Number 32,737  
PRO-TECHTOR INTERNATIONAL SERVICES  
20775 Norada Court, Saratoga, CA 95070-3018  
Telephone: (408) 778-3440*

I authorize my attorney to accept and follow instructions from TSAI, LEE & CHEN \_\_\_\_\_ regarding any matter related to this application or any patent that my issue from this application. This authorization shall remain valid until such time as I may revoke it in writing.

DECLARATION

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both,

under Title 18, United States Code, Section 1001, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Date: Dec 22/2003

Yung-Hsien Wu

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Date: \_\_\_\_\_

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*Inventor's residence and* \_\_\_\_\_

*Post Office Address:* \_\_\_\_\_

*Inventor's Citizenship:* \_\_\_\_\_